

AMENDMENTS TO THE SPECIFICATION

Replace paragraph 0001 with the following:

[0001] The invention disclosed in this application is related to the invention disclosed by U.S. patent application [[(Attorney Docket No. M4065.0937/P937)]] 10/765,911, filed concurrently with this application by Kristy A. Campbell, Terry L. Gilton, and John T. Moore, now issued as U.S. Patent No. 7,155,864. The entirety of this related application and patent is hereby incorporated by reference herein in its entirety.

Replace paragraph 0029 with the following:

[0029] Over and electrically coupled to the electrode [[18]] 16 is deposited a layer of host material 18, which incorporates metal ions, such as Mn+2, for example. The host material 18 can be an organic or inorganic molecular matrix (as indicated above) and can be formed by blanket deposition techniques, which may be followed by patterning and etching if desired, or, alternatively, may be formed by an in-via process; either deposition process may include CVD, sputtering, co-sputtering, thermal evaporation, or other known techniques. The host material 18 can be about 100 Å to about 2,000 Å thick.